## DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

ATTORNEY'S DOCKET NO.: TESSERA 3.0-196

As a below-named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original,

first and joint inventor (if plus					
for which a patent is sough	nt on the invention ent	itled: SEMICONDUCTOR	CHIP PACKAGE WITH		
INTERCONNECT STRUCTURE the specification of which					
is attached hereto					
was filed on as United States Application Number or PCT International Application Number and was amended					
on (if applicable).					
I hereby state that I have reviewed and un amendment specifically referred to above.	derstand the contents of the above-	dentified specification, including	the claims, as amended by any		
I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.					
I hereby claim foreign priority benefits un certificate, or § 365(a) of any PCT internat below and have also identified below any filing date before that of the application on	ional application which designated a foreign application for patent or inv	it least one country other than the	United States of America, listed		
PRIOR FOREIGN APPLICATION(S	)				
COUNTRY	APPLICATION NUMBER	DATE OF FILING (month, day, year)	PRIORITY CLAIMED		
			YES NO		
			YES NO NO		
			YES NO		
LISTING OF FOREIGN APPLICATIONS CONTINUED ON PAGE 3 HEREOF YES NO					
I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:					
Application Number: 60/203,190 Filing Date: May 8, 2000					
Application Number: Filing Date:					
I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s), or § 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:					
U.S. Parent Application Serial Number: Parent Filing		Date: Pare	ent Patent No.:		
U.S. Parent Application Serial Number:	Parent Filing Date:		ent Patent No.:		
PCT Parent Number:	Parent Filing Date:				
LISTING OF US APPLICATIONS CONTINUED ON PAGE 3 HEREOF:  YES  NO					
POWER OF ATTORNEY: As a named inventor, I hereby appoint the following registered practitioner(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.					
Lawrence I. Lerner, Reg. No. 19,516; Sidney David, Reg. No. 22,768; Joseph S. Littenberg, Reg. No. 20,832; Arnold H. Krumholz, Reg. No. 25,428; William L. Mentlik, Reg. No. 27,108; John R. Nelson, Reg. No. 26,573; Roy H. Wepner, Reg. No. 28,350; Stephen B. Goldman, Reg. No. 28,512; Paul H. Kochanski, Reg. No. 29,660; Marcus J. Millet, Reg. No. 28,241; Bruce H. Sales, Reg. No. 32,783; Daniel H. Bobis, Reg. No. 16,684; Keith E. Gilman, Reg. No. 32,1781; Robert B. Cohen, Reg. No. 32,768; Arnold B. Dornjeier, Reg. No. 29,736; Michael H. Teschner, Rev. No. 32,662; Gregory S. Gewirtz, Reg. No. 36,522; Jonathan A. David, Reg. No. 36,494; Shawn P. Foley, Reg. No. 33,071; Thomas M. Palisi, Reg. No. 36,629; Kimberly V. Perry, Reg. No. 43,612; Renee M. Robeson, Reg. No. 41,777; Raymond W. Augustin, Reg. No. 28,588; Harvey L. Cohen, Reg. No. 28,365; Michael J. Doherty, Reg. No. 40,592; Jeffrey S. Dickey, Reg. No. 35,856; J. Kirkland Douglass, Reg. No. 46,011; Matthew B. Dernier, Reg. No. 40,989; Scott S. Servilla, Reg. No. 40,806; Jeanne P. Vallebuona, Reg. No. 45,772; Edward D. Pergament, Reg. No. 43,346; Timothy J. Lubecki, Reg. No. 38,953; William Smith, Reg. No. 46,439; Timothy J. Bortree, Reg. No. 43,506; Yufeng Liu, Reg. No. 45,379; Christopher M. Pickett, Reg. No. 37,531.					
SEND CORRESPONDENCE TO:		IRECT TELEPHONE CALLS	ro:		
Customer Number 000530		(name and telephone number)			
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## . DECLARATION -- Page 2

## ATTORNEY DOCKET NO. TESSERA 3.0-196

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name): JOHN W. SMITH		, ,
Inventor's signature	_Date	06/19/01
Residence: Horseshoe Bay, TX 78657 Citizenship: USA Mailing Address: 2826 Aurora Horseshoe, Horseshoe Bay, TX 78657		
Full name of second joint inventor, if any (given name, family name) BELGACEM HABA		
Full name of second joint inventor, if any (given name, family name) BELGACEM HABA  Second Inventor's signature  Residence: Cupertino, CA 95014 Citizenship: Algeria  Mailing Address: 10541 Cypress Court, Cupertino, CA 95014	_Date	05/15/0/
Full name of third joint inventor, if any (given name, family name):		
Third Inventor's signature	_Date	
Residence: Citizenship: Mailing Address:		
Full name of fourth joint inventor, if any (given name, family name):		
Fourth Inventor's signature	_Date	
Residence: Citizenship: Mailing Address:		
Full name of fifth joint inventor (given name, family name):		
Fifth Inventor's signature	_Date	
Residence: Citizenship: Mailing Address:		
Full name of sixth joint inventor, if any (given name, family name):		
Sixth Inventor's signature	_Date	
Residence: Citizenship: Mailing Address:		
Full name of seventh joint inventor, if any (given name, family name):		
Seventh Inventor's signature	_Date	
Residence: Citizenship: Mailing Address:		
Full name of eighth joint inventor, if any (given name, family name):		
Eighth Inventor's signature		
Residence: Citizenship: Mailing Address:		
Additional inventors are being named on separately numbered sheets attached hereto.		308477_1.DOC